

L Number	Hits	Search Text	DB	Time stamp
1	520	vernier with pattern	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:03
2	274068	two with (dimension dimensional)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:04
3	79	(vernier with pattern) and (two with (dimension dimensional))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:04
4	61	substrate and ((vernier with pattern) and (two with (dimension dimensional)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:10
5	143817	photoresist photo adj resist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:11
6	30	(substrate and ((vernier with pattern) and (two with (dimension dimensional)))) and (photoresist photo adj resist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:59
7	30	(substrate and ((vernier with pattern) and (two with (dimension dimensional)))) and (photoresist photo adj resist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/03 10:59